

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEIFENG WANG	09/25/2015
XINGAO BIAN	09/25/2015
ZHONGQUAN SHI	09/25/2015
JIANZHONG SUN	09/25/2015
JING LI	09/25/2015
FEI XIONG	09/25/2015
WEI WANG	09/25/2015
RECEIVING PARTY DATA	
Name:	CHANGCHAI CO., LTD.
Street Address:	37 HUAIDE ROAD (NORTH)
City:	CHANGZHOU, JIANGSU
State/Country:	CHINA
Postal Code:	213002
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14849757
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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NAME OF SUBMITTER:	SUE Z SMITH
SIGNATURE:	//Sue Z Smith//
DATE SIGNED:	10/12/2015
Total Attachments: 2	

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ASSIGNMENT

WHEREAS, I, as below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

FUEL INJECTION CONTROL SYSTEM FOR A SINGLE-CYLINDER DIESEL ENGINE AND CONTROL METHOD THEREFOR

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Changchai Co., Ltd., a Chinese Corporation, with offices at 37 Huaide Road (North), Changzhou, Jiangsu, P.R. of China 213002, (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 14/849,757, Filing Date: September 10, 2015.

This assignment executed on the dates indicated below.

Weifeng WANG

Name of sole or 1st inventor

Execution date of U.S. Patent Application

Changzhou, China

Residence of sole or 1st inventor

Weifeng WANG

2015.9.25

Signature of sole or 1st inventor

Date of this assignment

Xingao BIAN

Name of 2nd joint inventor

Execution date of U.S. Patent Application

Changzhou, China

Residence of 2nd joint inventor

Xingao BIAN

2015.9.25

Signature of 2nd joint inventor

Date of this assignment

ADDITIONAL INVENTOR(S)

Zhongquan SHI

Name of 3rd joint inventor

Execution date of U.S. Patent Application

Changzhou, China

Residence of 3rd joint inventor

Zhongquan Shi

Signature of 3rd joint inventor

2015.9.25

Date of this assignment

Jianzhong SUN

Name of 4th joint inventor

Execution date of U.S. Patent Application

Changzhou, China

Residence of 4th joint inventor

Jianzhong SUN

Signature of 4th joint inventor

2015.9.25

Date of this assignment

Jing LI

Name of 5th joint inventor

Execution date of U.S. Patent Application

Changzhou, China

Residence of 5th joint inventor

Jing LI

Signature of 5th joint inventor

2015.9.25

Date of this assignment

Fei XIONG

Name of 6th joint inventor

Execution date of U.S. Patent Application

Changzhou, China

Residence of 6th joint inventor

Fei XIONG

Signature of 6th joint inventor

2015.9.25

Date of this assignment

Wei WANG

Name of 7th joint inventor

Execution date of U.S. Patent Application

Changzhou, China

Residence of 7th joint inventor

Wei WANG

Signature of 7th joint inventor

2015.9.25

Date of this assignment